COMPLIANT HALOGEN

**FREE** 





#### **Load Switch with Level-Shift**

PRODUCT SUMMARY				
V <sub>DS2</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)		
	0.165 at V <sub>IN</sub> = 4.5 V	± 1.2		
1.8 to 20	0.222 at V <sub>IN</sub> = 2.5 V	± 1.0		
	0.303 at V <sub>IN</sub> = 1.8 V	± 0.7		

#### **DESCRIPTION**

The Si1869DH includes a p- and n-channel MOSFET in a single SC70-6 package. The low on-resistance p-channel TrenchFET is tailored for use as a load switch. The n-channel, with an external resistor, can be used as a levelshift to drive the p-channel load-switch. The n-channel MOSFET has internal ESD protection and can be driven by logic signals as low as 1.5 V. The Si1869DH operates on supply lines from 1.8 V to 20 V, and can drive loads up to 1.2 A.

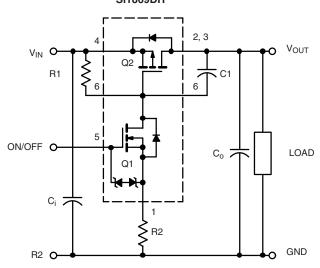
#### **FEATURES**

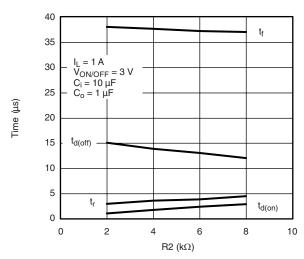
- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFETs: 1.8 V Rated
- ESD Protected: 2000 V On Input Switch, V<sub>ON/OFF</sub>
- 165 m $\Omega$  Low R<sub>DS(on)</sub>
- 1.8 to 20 V Input
- 1.5 to 8 V Logic Level Control
- Low Profile, Small Footprint SC70-6 Package
- Adjustable Slew-Rate
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

Level Shift for Portable Devices

#### **APPLICATION CIRCUITS** Si1869DH





Note: For R2 switching variations with other V<sub>IN</sub>/R1 combinations see Typical Characteristics

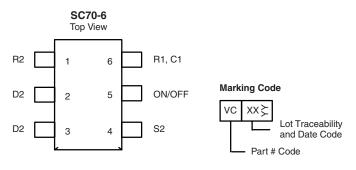
> Switching Variation R2 at V<sub>IN</sub> = 2.5 V, R1 = 20 k $\Omega$

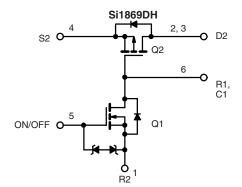
COI	COMPONENTS					
R1	Pull-Up Resistor	Typical 10 k $\Omega$ to 1 M $\Omega^*$				
R2	Optional Slew-Rate Control	Typical 0 to 100 k $\Omega^*$				
C1	Optional Slew-Rate Control	Typical 1000 pF				

<sup>\*</sup> Minimum R1 value should be at least 10 x R2 to ensure Q1 turn-on.

The Si1869DH is ideally suited for high-side load switching in portable applications. The integrated n-channel level-shift device saves space by reducing external components. The slew rate is set externally so that rise-times can be tailored to different load types.

#### **FUNCTIONAL BLOCK DIAGRAM**





Ordering Information: Si1869DH-T1-E3 (Lead (Pb)-free)

Si1869DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage (D2-S2)		$V_{DS}$	- 20		
Input Voltage		V <sub>IN</sub>	20	V	
ON/OFF Voltage		V <sub>ON/OFF</sub>	8		
Load Current	Continuous <sup>a, b</sup>	- IL	± 1.2	А	
Load Current	Pulsed <sup>b, c</sup>		± 3		
Continuous Intrinsic Diode Conduction <sup>a</sup>	I <sub>S</sub>	- 0.4			
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	1.0	W		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
ESD Rating, MIL-STD-883D Human Body Model (100 pF, 1500 Ω)		ESD	2	kV	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient (Continuous Current) <sup>a</sup>	R <sub>thJA</sub>	100	125	°C/W		
Maximum Junction-to-Foot (Q2)	R <sub>thJF</sub>	44	55	C/VV		

SPECIFICATIONS T <sub>J</sub> = 25 °C unless otherwise noted						
Parameter	Symbol	Symbol Test Conditions		Тур.	Max.	Unit
OFF Characteristics	OFF Characteristics					
Reverse Leakage Current	I <sub>FL</sub>	V <sub>IN</sub> = 8 V, V <sub>ON/OFF</sub> = 0 V			1	μΑ
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = - 0.4 A	0.4	0.6	1.1	V
ON Characteristics	ON Characteristics					
Input Voltage Range	V <sub>IN</sub>		1.8		20	V
Drain to Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 20			V
		$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 4.5 \text{ V}, I_D = 1.2 \text{ A}$		0.132	0.165	
On-Resistance (P-Channel) at 1 A	R <sub>DS(on)</sub>	$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 2.5 \text{ V}, I_D = 1.0 \text{ A}$		0.177	0.222	Ω
		$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 1.8 \text{ V}, I_D = 0.7 \text{ A}$		0.242	0.303	
On-State (P-Channel) Drain-Current	1	$V_{IN-OUT} \le 0.2 \text{ V}, V_{IN} = 5 \text{ V}, V_{ON/OFF} = 1.5 \text{ V}$	1			Α
	I <sub>D(on)</sub>	$V_{IN-OUT} \le 0.3 \text{ V}, V_{IN} = 3 \text{ V}, V_{ON/OFF} = 1.5 \text{ V}$	1			τ.

#### Notes:

- a. Surface mounted on FR4 board.
- b.  $V_{IN}$  = 20 V,  $V_{ON/OFF}$  = 8 V,  $T_A$  = 25 °C. c. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

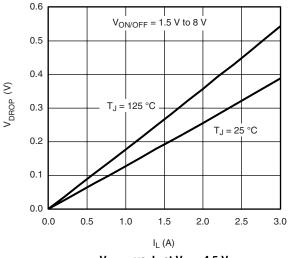
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



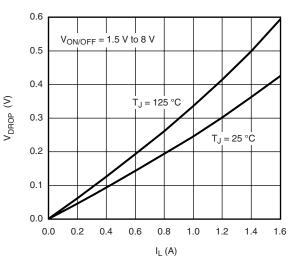




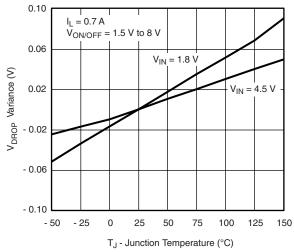
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



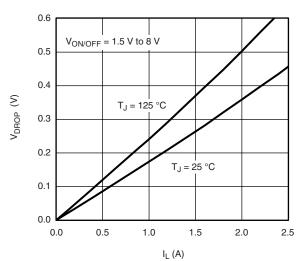
 $V_{DROP}$  vs.  $I_L$  at  $V_{IN}$  = 4.5 V



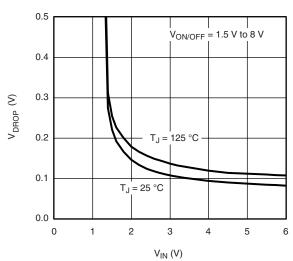
 $V_{DROP}$  vs.  $I_L$  at  $V_{IN}$  = 1.8 V



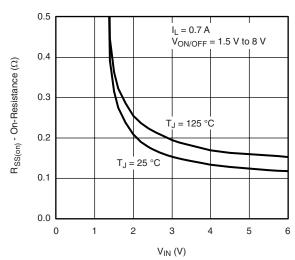
**V**<sub>DROP</sub> Variance vs. Junction Temperature



 $V_{DROP}$  vs.  $I_L$  at  $V_{IN}$  = 2.5 V



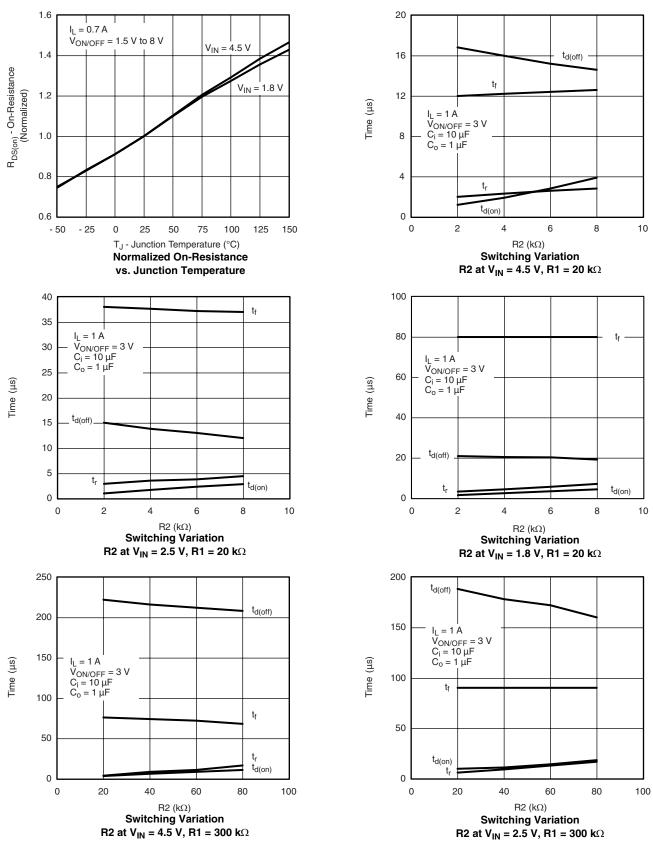
V<sub>DROP</sub> vs. V<sub>IN</sub> at I<sub>L</sub> = 0.7 A



On-Resistance vs. Input Voltage

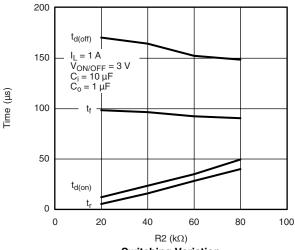
## VISHAY.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

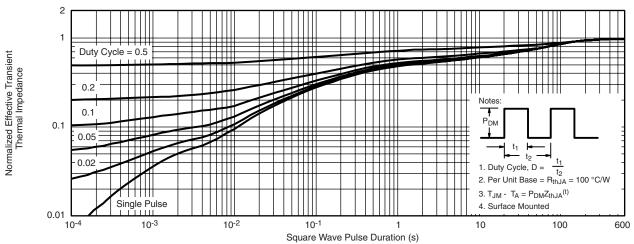




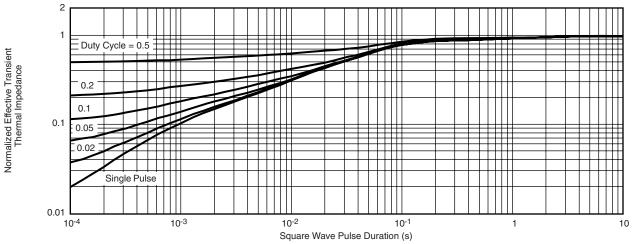
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Switching Variation R2 at V<sub>IN</sub> = 1.8 V, R1 = 300 k $\Omega$ 



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



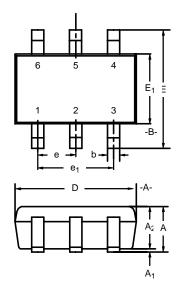
Normalized Thermal Transient Impedance, Junction-to-Foot

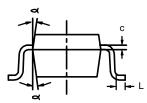
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#### SC-70: 6-LEADS





	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	_	1.10	0.035	_	0.043
A <sub>1</sub>	-	_	0.10	-	_	0.004
A <sub>2</sub>	0.80	_	1.00	0.031	_	0.039
b	0.15	_	0.30	0.006	_	0.012
С	0.10	-	0.25	0.004	-	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Ε	1.80	2.10	2.40	0.071	0.083	0.094
E <sub>1</sub>	1.15	1.25	1.35	0.045	0.049	0.053
е		0.65BSC			0.026BSC	;
e <sub>1</sub>	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
کے	7°Nom 7°Nom					

DWG: 5550



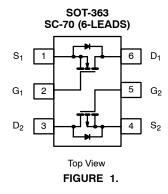
# Dual-Channel LITTLE FOOT® 6-Pin SC-70 MOSFET Copper Leadframe Version Recommended Pad Pattern and Thermal Performance

#### INTRODUCTION

The new dual 6-pin SC-70 package with a copper leadframe enables improved on-resistance values and enhanced thermal performance as compared to the existing 3-pin and 6-pin packages with Alloy 42 leadframes. These devices are intended for small to medium load applications where a miniaturized package is required. Devices in this package come in a range of on-resistance values, in n-channel and p-channel versions. This technical note discusses pin-outs, package outlines, pad patterns, evaluation board layout, and thermal performance for the dual-channel version.

#### **PIN-OUT**

Figure 1 shows the pin-out description and Pin 1 identification for the dual-channel SC-70 device in the 6-pin configuration. Both n-and p-channel devices are available in this package — the drawing example below illustrates the p-channel device.



For package dimensions see outline drawing SC-70 (6-Leads) (http://www.vishay.com/doc?71154)

#### **BASIC PAD PATTERNS**

See Application Note 826, Recommended Minimum Pad Patterns With Outline Drawing Access for Vishay Siliconix MOSFETs, (http://www.vishay.com/doc?72286) for the SC-70 6-pin basic pad layout and dimensions. This pad pattern is sufficient for the low-power applications for which this package is intended. Increasing the drain pad pattern (Figure 2) yields a reduction in thermal resistance and is a preferred footprint.

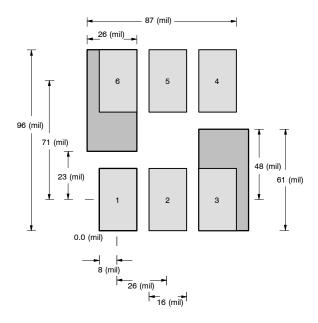


FIGURE 2. SC-70 (6 leads) Dual

#### EVALUATION BOARD FOR THE DUAL-CHANNEL SC70-6

The 6-pin SC-70 evaluation board (EVB) shown in Figure 3 measures 0.6 in. by 0.5 in. The copper pad traces are the same as described in the previous section, *Basic Pad Patterns*. The board allows for examination from the outer pins to the 6-pin DIP connections, permitting test sockets to be used in evaluation testing.

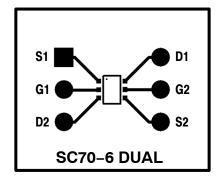
The thermal performance of the dual 6-pin SC-70 has been measured on the EVB, comparing both the copper and Alloy 42 leadframes. This test was then repeated using the 1-inch<sup>2</sup> PCB with dual-side copper coating.

A helpful way of displaying the thermal performance of the 6-pin SC-70 dual copper leadframe is to compare it to the traditional Alloy 42 version.

Document Number: 71405 www.vishay.com 12-Dec-03 1405



Front of Board SC70-6



Back of Board SC70-6

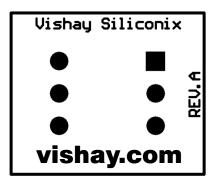


FIGURE 3.

#### THERMAL PERFORMANCE

Junction-to-Foot Thermal Resistance (the Package Performance)

Thermal performance for the dual SC-70 6-pin package is measured as junction-to-foot thermal resistance, in which the "foot" is the drain lead of the device as it connects with the body. The junction-to-foot thermal resistance for this device is typically 80°C/W, with a maximum thermal resistance of approximately 100°C/W. This data compares favorably with another compact, dual-channel package - the dual TSOP-6 which features a typical thermal resistance of 75°C/W and a maximum of 90°C/W.

#### **Power Dissipation**

The typical  $R\theta_{JA}$  for the dual-channel 6-pin SC-70 with a copper leadframe is 224°C/W steady-state, compared to 413°C/W for the Alloy 42 version. All figures are based on the 1-inch<sup>2</sup> FR4 test board. The following example shows how the thermal resistance impacts power dissipation for the dual 6-pin SC-70 package at varying ambient temperatures.

Alloy 42 Leadframe

ALLOY 42 LEADFRAME				
Room Ambient 25 °C Elevated Ambient 60 °C				
$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$	$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$			
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{413^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{413^{\circ}C/W}$			
$P_D = 303 \text{ mW}$	$P_D = 218 \text{ mW}$			

COOPER LEADFRAME				
Room Ambient 25 °C	Elevated Ambient 60 °C			
$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$	$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$			
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{224^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{224^{\circ}C/W}$			
$P_D = 558 \text{ mW}$	$P_D = 402 \text{mW}$			

Although they are intended for low-power applications, devices in the 6-pin SC-70 dual-channel configuration will handle power dissipation in excess of 0.5 W.

#### **TESTING**

To further aid the comparison of copper and Alloy 42 leadframes, Figures 4 and 5 illustrate the dual-channel 6-pin SC-70 thermal performance on two different board sizes and pad patterns. The measured steady-state values of  $R\theta_{JA}$  for the dual 6-pin SC-70 with varying leadframes are as follows:

LITTLE FOOT 6-PIN SC-70					
Alloy 42 Copper					
1) Minimum recommended pad pattern on the EVB board (see Figure 3).	518°C/W	344°C/W			
2) Industry standard 1-inch <sup>2</sup> PCB with maximum copper both sides.	413°C/W	224°C/W			

The results indicate that designers can reduce thermal resistance (θJA) by 34% simply by using the copper leadframe device as opposed to the Alloy 42 version. In this example, a 174°C/W reduction was achieved without an increase in board area. If an increase in board size is feasible, a further 120°C/W reduction can be obtained by utilizing a 1-inch<sup>2</sup>. PCB area.

The Dual copper leadframe versions have the following suffix:

Dual: Si19xxEDH Si15xxEDH Compl.:

Document Number: 71405 www.vishay.com





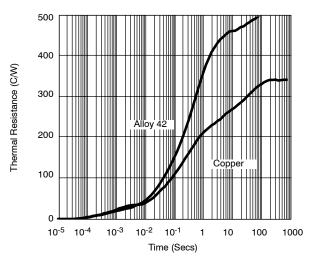


FIGURE 4. Dual SC70-6 Thermal Performance on EVB

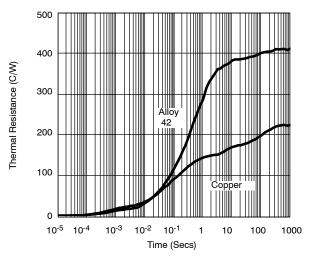
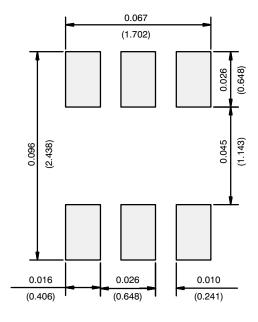


FIGURE 5. Dual SC70-6 Comparison on 1-inch<sup>2</sup> PCB



#### **RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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Revision: 02-Oct-12 Document Number: 91000

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